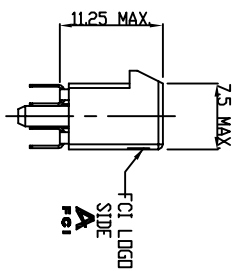
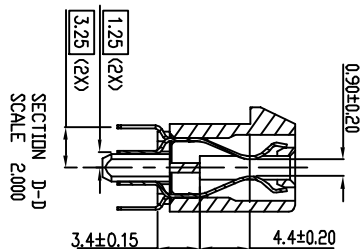
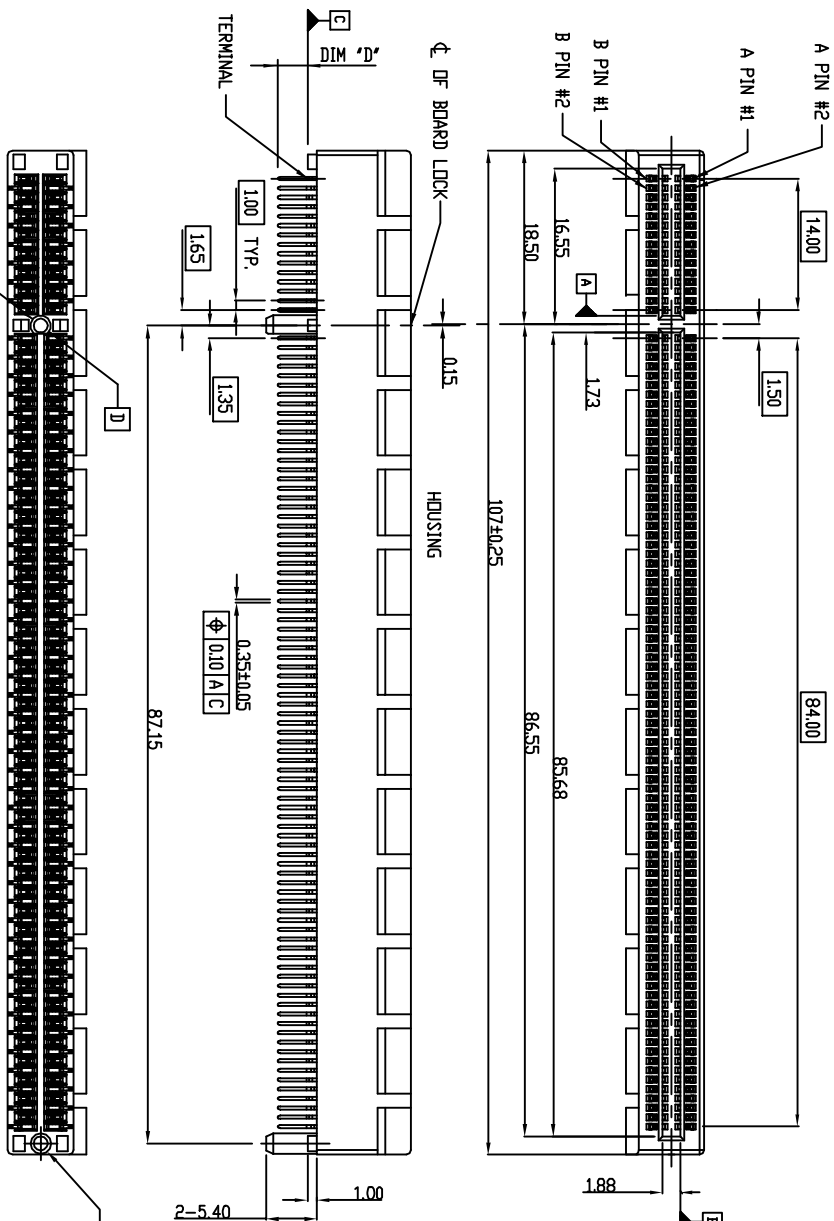


PROD NO
SEE NOTE

1 | 2

3

4



mat'l. code				tolerances unless otherwise specified				CUSTOMER COPY				title			
itr	ecn no	dr	date	linear	.XX ±.38	.XX ±.25	.XX ±.10	projection	MM	product family	PCI	code	sheet	1 of 4	code
A	106-0079	J.H	4/14/06	linear	.XX ±.38	.XX ±.25	.XX ±.10	projection	MM	PCI-E 200P	CARD EDGE	10054652	1 of 4		
				angles	0° ±2°										
				dr	JASON HSU	4/14/06									
				engr	JASON HSU	4/14/06									
				chf	STERLING LIN	4/14/06									
				appd	HC LOU	4/14/06									
sheet	revision	A	A	A	A	A	A	A	A	A	A	A	A	A	A
index	sheet	1	2	3	4										

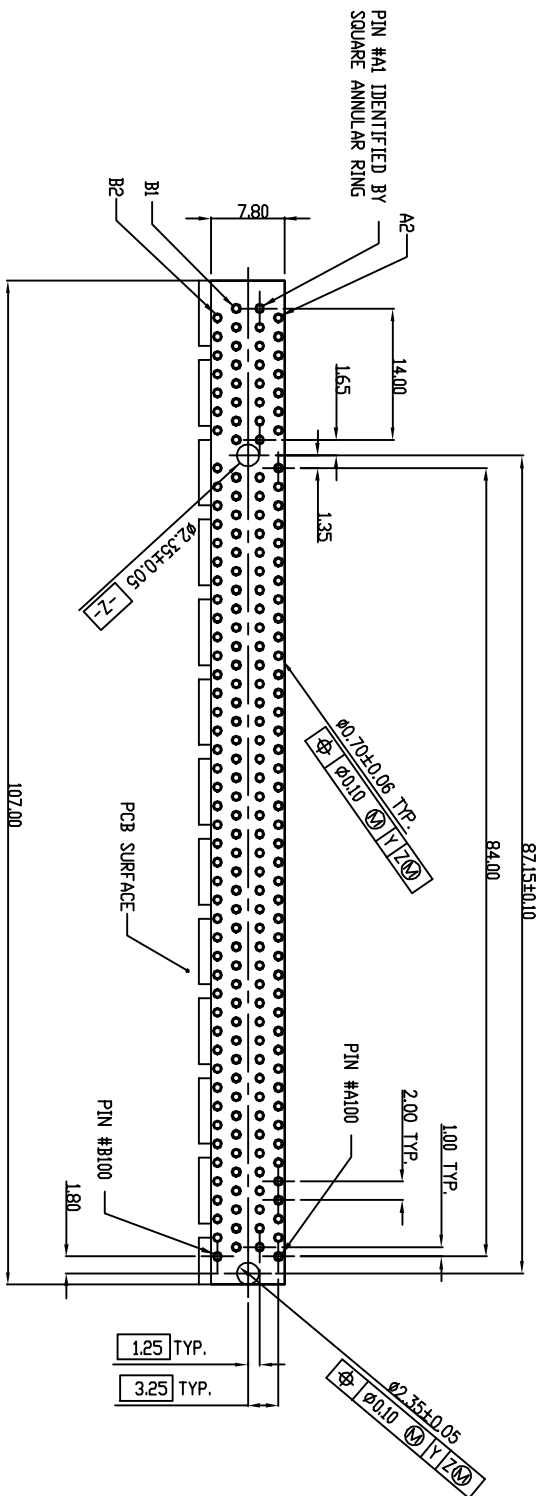
ACAD

3

code code
22526

4

MOTHER BOARD FOOTPRINT PATTERN
CONNECTOR SIDE SHOWN



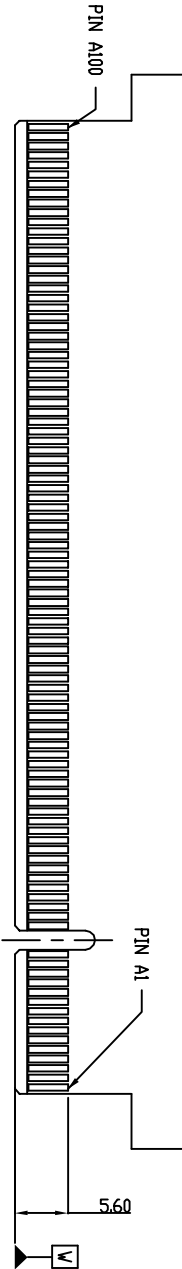
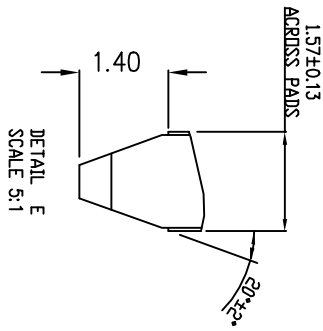
mod'l. code	itr	ecn no	dr	ddte	tolerances unless otherwise specified	CUSTOMER COPY	title	product family	code
A					.X ±.38	projection	PCI-E 200P CARD EDGE	PCI	—
					.XX ±.25	MM	size	family	code
					.XXX ±.10	MM	size	family	code
					0° ±2°	MM	size	family	code
					dr JASON HSU 4/14/06	MM	size	family	code
					engr JASON HSU 4/14/06	MM	size	family	code
					chr STERLING LIN 4/14/06	MM	size	family	code
					appl HC LIOU 4/14/06	MM	size	family	code
sheet	revision								sheet
index	sheet								2 of 4

ACAD

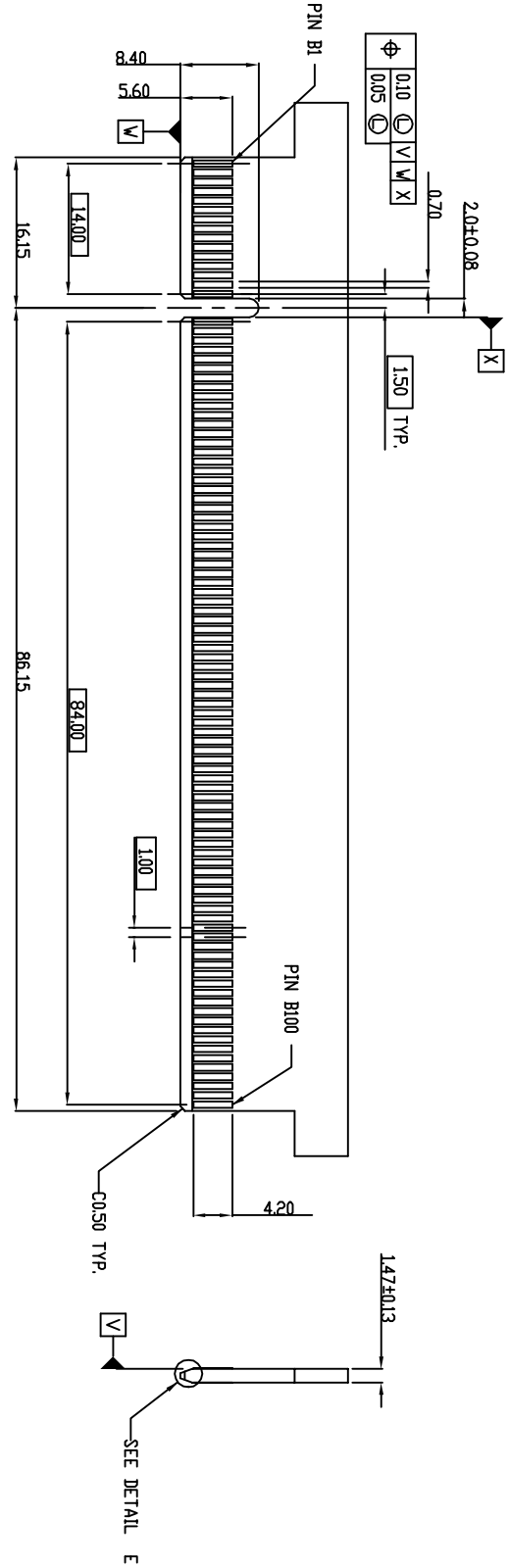
code code
22526

B

A



↑ I/O PANEL DIRECTION
PRIMARY (COMPONENT) SIDE



↓ I/O PANEL DIRECTION
SECONDARY (SOLDER) SIDE

mat'l. code	tolerances unless otherwise specified	CUSTOMER COPY	title	product family	code
ltr	ecn no	dr	date	linear	XX ±.25
A				angles	.XXX ±.10
				0° ±2°	
				dr	JASON HSU 4/14/06
				engr	JASON HSU 4/14/06
				chr	STERLING LIN 4/14/06
				appd	HC LIU 4/14/06
sheet	revision			scale	N/A
index	sheet				
				size	A4
				dwg no	10054652
				code	PCI
				sheet	3 of 4

ACAD

code 22526



1 | 2

3 |

4

NOTES:
1.MATERIAL:

HOUSING: THERMOPLASTIC WITH GLASS FIBER, UL94V-0,
COLOR IN BLACK.
CONTACTS: COPPER ALLOY.

2.FINISH:

CONTACTS: GOLD PLATING ON CONTACT AREA,
100 u"MIN. TIN/LEAD OR MATTE TIN (LEAD FREE OPTION) PLATING ON SOLDER TAILS,
50u"MIN. NICKEL UNDERPLATING OVER ALL.
SOLDER LOCKS: 100 u" TIN/LEAD OR MATTE TIN (LEAD FREE OPTION) PLATING ON SOLDER TAILS,
50u"MIN. NICKEL UNDERPLATING OVER ALL.

3. DURABILITY: 50 CYCLES.

4. ROHS COMPATIBLE PRODUCT SPECIFICATIONS

- a. PLATING: "LF" MEANS THE PRODUCT IS LEAD FREE, 25um min. MATTE PURE TIN OVER 1,27um MIN. NICKEL UNDERPLATE.
b. MANUFACTURING PROCESS COMPATIBILITY: THE HOUSING WILL WITHSTAND EXPOSURE TO 260C±5C° SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1,60MM THICK CIRCUIT BOARD.

PRODUCT NUMBER CODE

10054652 - X X X X X X X LF

LEAD FREE

HOUSING COLOR OPTIONS _____
1-BLACK

PEGS OPTIONS _____
0-PLASTIC PEGS

PACKAGING OPTIONS
T-TRAY PACKAGING

RESERVE
0

TERMINAL PLATING OPTIONS _____

0-50u" NI UNDERPLATE
30u" Au CONTACT AREA
100u" TIN TAIL AREA -----COMPATIBLE ROHS
1-50u" NI UNDERPLATE
15u" Au CONTACT AREA
100u" TIN TAIL AREA -----COMPATIBLE ROHS
2-50u" NI UNDERPLATE
GOLD FLASH CONTACT AREA
100u" TIN TAIL AREA -----COMPATIBLE ROHS

TAIL LENGTH OPTIONS

	DIM "D"	SUGGESTED PCB THICKNESS
1	3.10	2.36±0.10
2	2.54	1.56±0.10

mat'l. code		tolerances unless otherwise specified		CUSTOMER COPY		A FCI www.fciconnect.com	
lfr	ecn no	dr	date	lineor	projection	title	
A				.XX ±.25		PCI-E 200P CARD EDGE	
				.XXX ±.10			
				angles 0° ±2°	MM	product family PCI	code
				dr JASON HSU 4/14/06			size dwg no
				engr JASON HSU 4/14/06	scale	10054652	sheet
				chf STERLING LIN 4/14/06			4 of 4
				appd HC LOU 4/14/06			
sheet	revision						
index	sheet						

1 | 2

3 |

4

ACAD

code code
22526